

Application Data Sheet

Application Information

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|---|--|
| Application Type:: | Regular |
| Subject Matter:: | Utility |
| CD-ROM or CD-R?:: | None |
| Computer Readable Form (CRF)?:: | No |
| Title:: | METHOD FOR MANUFACTURING A SEMICONDUCTOR DEVICE BY USING A DRY ETCHING TECHNIQUE |
| Attorney Docket Number:: | 081848-0190 |
| Request for Early Publication?:: | No |
| Request for Non-Publication?:: | No |
| Suggested Drawing Figure:: | 1 |
| Total Drawing Sheets:: | 6 |
| Small Entity?:: | No |
| Petition included?:: | No |
| Secrecy Order in Parent Appl.?:: | No |

Applicant Information

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| Applicant Authority Type:: | Inventor |
| Primary Citizenship Country:: | Japan |
| Status:: | Full Capacity |
| Given Name:: | Nobuyuki |
| Family Name:: | IKEZAWA |
| City of Residence:: | Kanagawa |
| Country of Residence:: | Japan |
| Street of mailing address:: | c/o NEC Electronics Corporation 1753 Shimonumabe, Nakahara-ku Kawasaki, Kanagawa, 211-8668 |

Country of mailing address:: Japan

Correspondence Information

Correspondence Customer Number:: 22428

E-Mail address:: PTOMailWashington@Foley.com

Representative Information

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|---|-------|--|
| Representative Customer Number:: | 22428 | |
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Domestic Priority Information

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|----------------------|--------------------------|-----------------------------|-----------------------------|
| Application:: | Continuity Type:: | Parent Application:: | Parent Filing Date:: |
| | | | |

Foreign Priority Information

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|------------------|-----------------------------|----------------------|---------------------------|
| Country:: | Application number:: | Filing Date:: | Priority Claimed:: |
| Japan | 2003-032916 | 02/10/2003 | Yes |
| Japan | 2003-367285 | 10/28/2003 | Yes |

Assignee Information

Assignee name:: NEC Electronics Corporation